MA27V04

Silicon epitaxial planar type

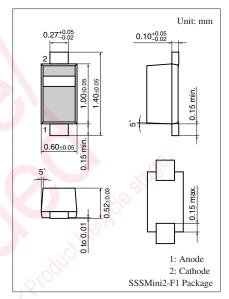
For VCO

■ Features

- \bullet Good linearity and large capacitance-ratio in $C_D V_R$ relation
- Small series resistance r_D
- SSS-Mini type package, allowing downsizing of equipment and automatic insertion through the taping package

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V_R	6	V	
Junction temperature	T_{j}	125	°C	
Storage temperature	T_{stg}	-55 to +125	°C	



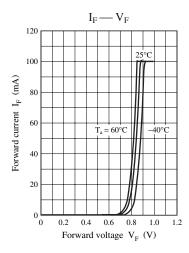
Marking Symbol: 4

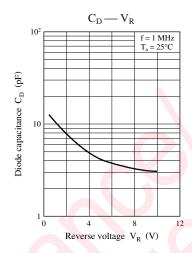
■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

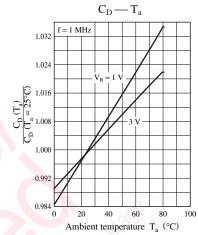
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current	I_R	$V_R = 5 \text{ V}$	1.60		10	nA
Diode capacitance	$C_{D(1V)}$	$V_R = 1 \text{ V, } f = 1 \text{ MHz}$	10.0		11.1	pF
100	C _{D(3V)}	$V_R = 3 \text{ V, f} = 1 \text{ MHz}$	5.8		6.4	
Series resistance *	r_{D}	$V_R = 3 \text{ V, f} = 470 \text{ MHz}$			0.35	Ω

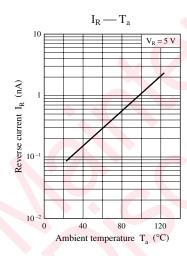
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. Absolute frequency of input and output is 470 MHz
- 3. *: Measuring instrument: YHP MODEL 4191A RF IMPEDANCE ANALYZER









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